# 2SC3937G

### Silicon NPN epitaxial planar type

For UHF band low-noise amplification

#### Features

- Low noise figure NF
- High forward transfer gain  $|S_{21e}|^2$
- High transition frequency f<sub>T</sub>
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

### Absolute Maximum Batings $T_c = 25^{\circ}C$

Absolute Maximum Hatings $T_a = 25$ C							
Parameter	Symbol	Rating	Unit				
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	15	V				
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	10	V				
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	2	V				
Collector current	I <sub>C</sub>	80	mA				
Collector power dissipation	P <sub>C</sub>	150	mW				
Junction temperature	Tj	150	°C				
Storage temperature	T <sub>stg</sub>	-55 to +150	°C				

#### Package

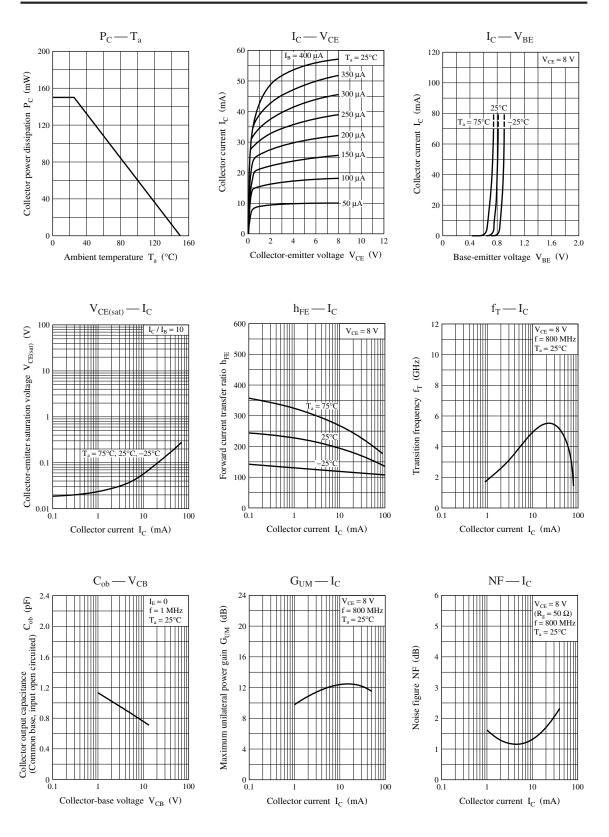
- Code
  - SMini3-F2
- Marking Symbol: 2W
- Pin Name
  - 1. Base
  - 2. Emitter
  - 3. Collector

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 15 \text{ V}, I_E = 0$			1	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = 1 V, I_C = 0$			1	μΑ
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = 8 V, I_C = 20 mA$	50		300	_
	h <sub>FE2</sub>	$V_{CE} = 1 V, I_C = 3 mA$	80		280	
Transition frequency	f <sub>T</sub>	$V_{CE} = 8 V, I_C = 20 mA, f = 0.8 GHz$		6		GHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		0.7	1.2	pF
(Common base, input open circuited)						
Forward transfer gain	$ S_{21e} ^2$	$V_{CE} = 8 V, I_C = 20 mA, f = 0.8 GHz$		13		dB
Maximum unilateral power gain	G <sub>UM</sub>	$V_{CE} = 8 V, I_C = 20 mA, f = 0.8 GHz$		14		dB
Noise figure	NF	$V_{CE} = 8 V, I_C = 7 mA, f = 0.8 GHz$		1.0	1.7	dB

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

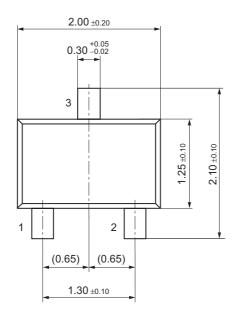
### Panasonic

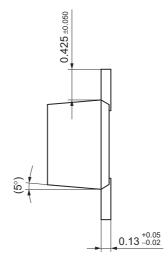


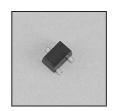
## **Panasonic**

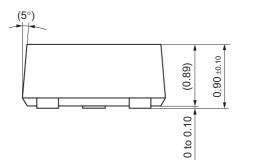
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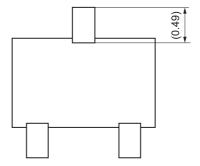
Unit: mm











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